2020

Panasonic

INDUSTRY

Conductive Polymer Hybrid Aluminum Electrolytic Capacitors

Products Catalog



Guidelines and precautions regarding the technical information and use of our products described in this online catalog.

- If you want to use our products described in this online catalog for applications requiring special qualities or reliability, or for applications where the failure or malfunction of the products may directly jeopardize human life or potentially cause personal injury (e.g. aircraft and aerospace equipment, traffic and transportation equipment, combustion equipment, medical equipment, accident prevention, anti-crime equipment, and/or safety equipment), it is necessary to verify whether the specifications of our products fit to such applications. Please ensure that you will ask and check with our inquiry desk as to whether the specifications of our products fit to such applications use before you use our products.
- The quality and performance of our products as described in this online catalog only apply to our products when used in isolation. Therefore, please ensure you evaluate and verify our products under the specific circumstances in which our products are assembled in your own products and in which our products will actually be used.
- If you use our products in equipment that requires a high degree of reliability, regardless of the application, it is recommended that you set up protection circuits and redundancy circuits in order to ensure safety of your equipment.
- The products and product specifications described in this online catalog are subject to change for improvement without prior notice. Therefore, please be sure to request and confirm the latest product specifications which explain the specifications of our products in detail, before you finalize the design of your applications, purchase, or use our products.
- The technical information in this online catalog provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.
- If any of our products, product specifications and/or technical information in this online catalog is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially with regard to security and export control, shall be observed.

<Regarding the Certificate of Compliance with the EU RoHS Directive/REACH Regulations>

- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.
- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

We do not take any responsibility for the use of our products outside the scope of the specifications, descriptions, guidelines and precautions described in this online catalog.



Notices

■ Applicable laws and regulations

- •This product complies with the RoHS Directive (Restriction of the use of certain hazardous substances in electrical and electronic equipment (DIRECTIVE 2011/65/EU and (EU)2015/863)).
- No Ozone Depleting Chemicals(ODC's), controlled under the Montreal Protocol Agreement, are used in producing this product.
- We do not use PBBs or PBDEs as brominated flame retardants.
- Export procedure which followed export related regulations, such as foreign exchange and a foreign trade method, on the occasion of export of this product.
- These products are not dangerous goods on the transportation as identified by UN(United Nations) numbers or UN classification.

Limited applications

- This capacitor is designed to be used for electronics circuits such as audio/visual equipment, home appliances, computers and other office equipment, optical equipment, measuring equipment.
- High reliability and safety are required [be / a possibility that incorrect operation of this product may do harm to a human life or property] more. When use is considered by the use, the delivery specifications which suited the use separately need to be exchanged.

■ Intellectual property rights and licenses

• The technical information in this specification provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.

Items to be observed

■ For specification

- This specification guarantees the quality and performance of the product as individual components. The durability differs depending on the environment and the conditions of usage.

 Before use, check and evaluate their compatibility with actual conditions when installed in the products. When safety requirements cannot be satisfied in your technical examination, inform us immediately.
- Do not use the products beyond the specifications described in this document.

Upon application to products where safety is regarded as important

Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other signification damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/ gas equipment, rotating rotating equipment, and disaster/crime prevention equipment.

- (1) The system is equipped with a protection circuit and protection device.
- (2) The system is equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.

■ Conditions of use

- Before using the products, carefully check the effects on their quality and performance, and determined whether or not they can be used. These products are designed and manufactured for general-purpose and standard use in general electronic equipment. These products are not intended for use in the following special conditions.
 - (1) In liquid, such as Water, Oil, Chemicals, or Organic solvent.
 - (2) In direct sunlight, outdoors, or in dust.
 - (3) In vapor, such as dew condensation water of resistive element, or water leakage, salty air, or air with a high concentration corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NOx.
 - (4) In an environment where strong static electricity or electromagnetic waves exist.
 - (5) Mounting or placing heat-generating components or inflammables, such as vinyl-coated wires, near these products.
 - (6) Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin and other material.
 - (7) Using resolvent, water or water-soluble cleaner for flux cleaning agent after soldering. (In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues)
 - (8) Using in the atmosphere where strays acid or alkaline.
 - (9) Using in the atmosphere where there are excessive vibration and shock.
- Please arrange circuit design for preventing impulse or transitional voltage.
 Do not apply voltage, which exceeds the full rated voltage when the capacitors receive impulse voltage, instantaneous high voltage, high pulse voltage etc.
- Our products there is a product are using an electrolyte solution. Therefore, misuse can result in rapid deterioration of characteristics and functions of each product. Electrolyte leakage damages printed circuit and affects performance, characteristics, and functions of customer system.



Application guidelines (Hybrid)

1. Circuit design

1.1 Operating temperature and frequency

Electrical characteristics of the capacitor are likely to change due to variation in temperature and/or frequency. Circuit designers should take these changes into consideration.

(1) Effects of operating temperature on electrical parameters

At higher temperatures : leakage current and capacitance increase while equivalent series resistance

(ESR) decreases.

At lower temperatures : leakage current and capacitance decrease while equivalent series resistance

(ESR) increases.

(2) Effects of frequency on electrical parameters

At higher frequencies : capacitance and impedance decrease while tan d increases.

At lower frequencies : heat generated by ripple current will rise due to an increase in equivalent

series resistance (ESR).

1.2 Operating temperature and life expectancy

(1) Expected life is affected by operating temperature. Generally, each 10 °C reduction in temperature will double the expected life. Use capacitors at the lowest possible temperature below the upper category temperature.

(2) If operating temperatures exceed the upper category limit, rapid deterioration of electrical parameter will occur and irreversible damage will result.

Check for the maximum capacitor operating temperatures including ambient temperature, internal capacitor temperature rise due to ripple current, and the effects of radiated heat from power transistors, IC's or resistors.

Avoid placing components, which could conduct heat to the capacitor from the back side of the circuit board.

(3) The formula for calculating expected life at lower operating temperatures is as follows;

$$L_2 = L_1 \times 2^{\frac{T_1-T_2}{10}}$$

 L_1 : Guaranteed life (h) at temperature, T_1 °C

L2 : Expected life (h) at temperature, T2 °C

T₁ : Upper category temperature + temperature rise due to rated ripple current (°C)

T2 : Actual operating temperature, ambient temperature + temperature rise due to ripple current (°C)

(4) Please use according to the lifetime as noted in this specification. Using products beyond end of the lifetime may change characteristics rapidly, short-circuit, operate pressure relief vent, or leak electrolyte.

1.3 Common application conditions to avoid

The following misapplication load conditions will cause rapid deterioration of a capacitor's electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur, causing the pressure relief vent to operate and resultant leakage of electrolyte. Under extreme conditions, explosion and fire ignition could result. The leaked electrolyte is combustible and electrically conductive.

(1) Reverse voltage

DC capacitors have polarity. Therefore, please do not apply the reverse voltage. Verify correct polarity before insertion.

(2) Charge / Discharge applications

Standard capacitors are not suitable for use in repeating charge/discharge applications. For charge/discharge applications, consult us with your actual application condition.

For rush current, please to nor exceed 100 A.

(3) ON-OFF circuit

Do not use capacitors in circuit where ON-OFF switching is repeated more than 10000 times/per day. In case of applying to the theses ON-OFF circuit, consult with us about circuit condition and so on.

(4) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time.

Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(5) Ripple current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents. In addition, consult us if the applied ripple current is to be higher than the maximum specified value. Ensure that rated ripple currents that superimposed on low DC bias voltages do not cause reverse voltage conditions.

Even if it is within a rated ripple current, in case the practical use is over the pre described endurance lifetime, it causes the increase of deterioration of ESR characteristic and the internal generation heat by ripple current. Due to this, there is some possibility of vent open, bulging of sleeve and rubber, electrolyte leakage, and shot circuit, explosion and ignition in the worst case.



1.4 Using two or more capacitors in parallel

The circuit resistance can closely approximate the series resistance of the capacitor, causing an imbalance of ripple current loads within the capacitors. Careful wiring methods can minimize the possible application of an excessive ripple current to a capacitor.

Moreover, please do not use it in series.

1.5 Capacitor mounting considerations

(1) Double-sided circuit boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board.

(2) Clearance for case mounted pressure relief (≥ φ10 mm)

Capacitors with case mounted pressure relief require sufficient clearance to allow for proper pressure relief operation.

The minimum clearance are dependent on capacitor diameters as follows.

- · ≥ $\phi 10 \text{ mm}$: 2 mm minimum
- (3) Wiring near the pressure relief ($\ge \varphi 10 \text{ mm}$)

Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief. Flammable, high temperature gas that exceeds $100\,^{\circ}$ C may be released which could dissolve the wire insulation and ignite.

(4) Circuit board patterns under the capacitor

Avoid circuit board runs under the capacitor, as an electrical short can occur due to an electrolyte leakage.

1.6 Electrical isolation of the capacitor

Completely isolate the capacitor as follows.

· Between the cathode and the case and between the anode terminal and other circuit paths.

1.7 Capacitor coating

The laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor.

2. Capacitor handling techniques

2.1 Considerations before using

- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption.

If required, this voltage can be discharged with a resistor with a value of about $1 \text{ k}\Omega$.

(3) Capacitors stored for a long period of time may exhibit an increase in leakage current.

This can be corrected by gradually applying rated voltage in series with a resistor of approximately 1 k Ω .

- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used.

The seal integrity can be damaged and loss of electrolyte/ shortened life can result.

2.2 Capacitor insertion

- (1) Verify the correct capacitance and rated voltage of the capacitor.
- (2) Verify the correct polarity of the capacitor before insertion.
- (3) Verify the correct terminal dimension and land pattern size before mount to avoid stress on the terminals.
- (4) Excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Reflow soldering

(1) Surface-mount type capacitor are exclusively for reflow soldering.

When reflow solder is used an ambient heat condition system such as the simultaneous use of infrared and hot-air is recommended.

(2) Observe proper soldering conditions (temperature, time, etc.). Do not exceed the specified limits.

If the peak temperature is high or if the heating time is long, it may cause deterioration of the electrical characteristics and life characteristics.

Recommended soldering condition is a guideline for ensuring the basic characteristics of the components, but not for the stable soldering conditions. Conditions for proper soldering should be set up according to individual conditions.

- * The Temperature on capacitor top shall be measured by using thermal couple that is fixed firmly by epoxy glue.
- (3) In case of use in 2 times reflow, 2nd reflow must be done when the capacitor's temperature return back to normal level.
- (4) In our recommended reflow condition, the case discoloration and the case swelling might be slightly generated. But please acknowledge that these two phenomena do not influence the reliability of the product.
- (5) The crack on top marking might be occurred by reflow heat stress. But please acknowledge that it does not influence the reliability of the product.
- (6) VPS (Vapor Phase Soldering) reflow can cause significant characteristics change and/ or mounting failure due to deformation by acute temperature rise.
 - VPS is acceptable provided that the process does not exceed recommended reflow profile and temperature rise is less than 3 degC/sec. Please contact Panasonic for detailed conditions.



2.4 Manual soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperature of 350 °C for 3 seconds or less.
- (2) If a soldered capacitor must be removed and reinserted, avoid excessive stress on the capacitor leads.
- (3) Avoid physical contacts between the tip of the soldering iron and capacitors to prevent or capacitor failure.

2.5 Capacitor handling after soldering

- (1) Avoid moving the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal. The capacitor may break from element portion due to a torque at outer rim, causing a large stress to terminals.
- (2) Do not use the capacitor as a handle when moving the circuit board assembly. The total weight of the board would apply to element portion through terminals, and the capacitor may break.
- (3) Avoid striking the capacitor after assembly to prevent failure due to excessive shock. The capacitor may break due to excessive shock or load above specified range.

2.6 Circuit board cleaning

(1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up to 5 minutes and up to 60 °C maximum temperatures. The boards should be thoroughly rinsed and dried. The use of ozone depleting cleaning agents is not recommended for the purpose of protecting our environment.

[Target solvent]

Pine Alpha ST-100S, Aqua Cleaner 210SEP, Clean-thru 750H / 750L / 710M, Sunelec B-12, Sunelec B-12, Cold Cleaner P3-375, Techno Cleaner 219, DK Be-clear CW-5790,

Telpene Cleaner EC-7R, Technocare FRW-17 / FRW-1 / FRV-1

- (2) Avoid using the following solvent groups unless specifically allowed in the specification;
 - (a) Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure.

For solvent resistant capacitors, carefully follow the temperature and time requirements based on the specification. 1,1,1-trichloroethane should never be used on any aluminum electrolytic capacitor.

(b) Alkaline solvents : could react and dissolve the aluminum case.

(c) Petroleum based solvents : deterioration of the rubber seal could result.(d) Xylene : deterioration of the rubber seal could result.

(e) Acetone : removal of the ink markings on the vinyl sleeve could result.

- (3) A thorough drying after cleaning is required to remove residual cleaning solvents that may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the upper category temperature of the capacitor.
- (4) Monitor the contamination levels of the cleaning solvents during use in terms of electrical conductivity, pH, specific gravity, or water content.
 - Chlorine levels can rise with contamination and adversely affect the performance of the capacitor. Control the flux density in the cleaning agent to be less than 2 mass%.
- (5) Depending on the cleaning method, the marking on a capacitor may be erased or blurred.
- * Please consult us if you are not certain about acceptable cleaning solvents or cleaning methods.

2.7 Mounting adhesives and coating agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents.

Also, avoid the use of chloroprene based polymers.

Harden on dry adhesive or coating agents well lest the solvent should be left.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

2.8 Fumigation

In exporting electronic appliances with aluminum electrolytic capacitors, in some cases fumigation treatment using such halogen compound as methyl bromide is conducted for wooden boxes.

If such boxes are not dried well, the halogen left in the box is dispersed while transported and enters in the capacitors inside.

This possibly causes electrical corrosion of the capacitors. Therefore, after performing fumigation and drying make sure that no halogen is left.

Don't perform fumigation treatment to the whole electronic appliances packed in a box.

Leave more than 1/3 of the sealing portion open, and do not cover that portion with any adhesives or coating.

2.9 Flux

If you use a halogen type (Chlorine type, Bromine type, etc.) high-activity flux, please use it after confirmation in advance, as it may have an impact on performance and reliability of this product due to the residue of the flux.



3. Precautions for using capacitors

3.1 Environmental conditions

Capacitors should not be stored or used in the following environments.

- (1) Exposure to temperatures above the upper category or below the lower category temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, chlorine compound, bromine, bromine compound or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

Even within the specified requirements, a large vibration acceleration may be applied due to resonance, so be sure to evaluate and confirm with the actual product.

3.2 Electrical precautions

- (1) Avoid touching the terminals of a capacitor as a possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuiting the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.
- (3) A low-molecular-weight-shiroxane which is included in a silicon material shall causes abnormal electrical characteristics.

4. Emergency procedures

(1) If the pressure relief of the capacitor operates, immediately turn off the equipment and disconnect from the power source.

This will minimize an additional damage caused by the vaporizing electrolyte.

(2) Avoid contact with the escaping electrolyte gas, which can exceed 100 °C temperatures.

If electrolyte or gas enters the eye, immediately flush the eye with large amounts of water.

If electrolyte or gas is ingested by mouth, gargle with water.

If electrolyte contacts the skin, wash with soap and water.

5. Long term storage

(1) Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time.

If used without reconditioning, an abnormally high current will be required to restore the oxide film.

This surge current could cause the circuit or the capacitor to fail.

Expiration date is 42 months from outgoing inspection date.

For storage condition, keep room temperature (5 $^{\circ}$ C to 35 $^{\circ}$ C) and humidity (45 $^{\circ}$ K to 85 $^{\circ}$ K) where direct sunshine doesn't reach.

(2) Environmental conditions

Do not store under condition outside the area described in the specification, and also under conditions listed below.

- (a) Exposure to temperatures above the upper category or below the lower category temperature of the capacitor.
- (b) Direct contact with water, salt water, or oil.
- (c) High humidity conditions where water could condense on the capacitor.
- (d) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, Chlorine compound, Bromine, Bromine compound or ammonia.
- (e) Exposure to ozone, radiation, or ultraviolet rays.
- (f) Vibration and shock conditions exceeding specified requirements.



6. Capacitor disposal

When disposing capacitors, use one of the following methods.

- (1) Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise).
- (2) Dispose as solid waste.

NOTE: Local laws may have specific disposal requirements which must be followed.

The precautions in using aluminum electrolytic capacitors follow the "Safety application guide for the use in fixed aluminum electrolytic capacitors for electronic equipment", RCR-2367D issued by JEITA in October 2017.

Please refer to the above application guide for details.

■ AEC-Q200 compliant

The products are tested based on all or part of the test conditions and methods defined in AEC-Q200. Please consult with Panasonic for the details of the product specification and specific evaluation test results, etc., and please review and approve Panasonic's product specification before ordering.

* Intellectual property right

We, Panasonic Group are providing the product and service that customers can use without anxiety, and are working positively on the protection of our products under intellectual property rights.

Representative patents relating to Conductive Polymer Hybrid Aluminum Electrolytic Capacitors are as follows:

US Patent No.7497879, No.7621970, No.9208954

JP Patent No.5360250 EP Patent No.1808875



Line up

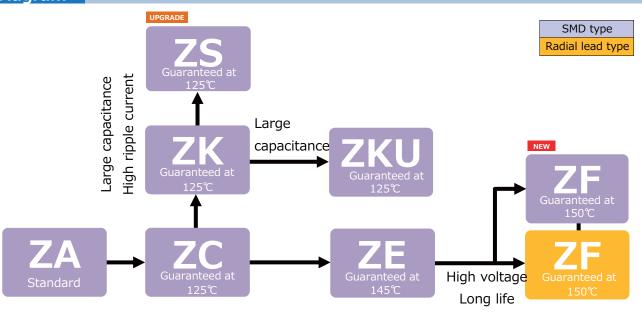
Surface mount type

Series	Part No.	o. Features		cap.	pple	emp.	life	Category temperature	Rated voltage	ESR	Capacitance range	code	Si (m	
Sei	r die ivo.	reactives	Small	Large	High ri	High to	Long	range (℃)	' range (mQ)		(μF)	Size	φD	L
		Low ESR							25 to 50	80 to 120	10 to 33	С	5.0	5.8
		High ripple current							25 to 63	50 to 120	10 to 56	D	6.3	5.8
ZA	EEHZA	Long life	•					-55 to 105	23 10 03	30 to 80	22 to 100	D8	6.3	7.7
		~							25 to 80	27 to 45	22 to 220	F	8.0	10.2
		105 ℃ 10000 h								20 to 36	33 to 330	G	10.0	10.2
		Low ESR							25 to 50	80 to 120	10 to 33	С	5.0	5.8
		High ripple current							25 to 63	50 to 120	10 to 56	D	6.3	5.8
ZC	EEHZC		•				•	-55 to 125	25 to 80	30 to 80	22 to 100	D8	6.3	7.7
		Long life								27 to 45	22 to 220	F	8.0	10.2
		125 ℃ 4000 h							23 10 80	20 to 36	33 to 330	G	10.0	10.2
		Large capacitance								80 to 100	33 to 47	С	5.0	5.8
		High ripple current								50 to 60	56 to 82	D	6.3	5.8
ZK	EEHZK		•	•	•		ullet	-55 to 125	25 to 35	30 to 35	100 to 150	D8	6.3	7.7
		Long life								27	180 to 270	F	8.0	10.2
		125 ℃ 4000 h								20	330 to 470	G	10.0	10.2
										80 to 100	39 to 56	С	5.0	5.8
		Large capacitance								50 to 60	68 to 100	D	6.3	5.8
ZKU	EEHZKU-	Long life	•	•	•		ullet	-55 to 125	25 to 35	30 to 35	120 to 180	D8	6.3	7.7
		125 ℃ 4000 h								27	220 to 330	F	8.0	10.2
										20	390 to 560	G	10.0	10.2
ZE	EEHZE	145 ℃ 2000 h					•	-55 to 145	25 to 63	27 to 40	33 to 220	F	8.0	10.2
	CCUZC	135 ℃ 4000 h				•	•	-55 (0 145	25 10 63	20 to 30	56 to 330	G	10.0	10.2
NEW ZF	EEHZF	150 ℃ 1000 h						-55 to 150	25 to 63	27 to 40	33 to 150	F	8.0	10.2
		120 C 1000 U					•	-35 (0 150	25 10 63	20 to 30	56 to 270	G	10.0	10.2
UPGRAD	DE EEUZC	125 ℃ 4000 h					_	EE to 125	25 to 63	14 to 19	100 to 470	G12	10.0	12.5
ZS	EEHZS	125 C 4000 N		•	•		•	-55 to 125	25 10 63	11 to 15	150 to 560	G16	10.0	16.5

Radial lead type

Series	Part No.	Features	Small size Large cap.	High temn	Long life	Category temperature range (℃)	Rated voltage range (V)	ESR (mΩ)	Capacitance range (µF)	Size code	Siz (m φD	
ZF	EEHAZF	150 ℃ 1000 h		•	•	-55 to 150	25 to 63	27 to 40	33 to 150	F	8.0	9.5
	LLI 1/ \ZI	130 6 1000 11				33 to 130	25 10 05	20 to 30	56 to 270	G	10.0	9.5

Diagram





Siz	e • I	ESR	Mat	rix	list															
V	μF Series	10	22	27	33	39	47	56	68	82	100	120	150	180	220	270	330	390	470	560
	ZA		C(80)		C(80)		D(50)	D(50)	D8(30)		D8(30)		F(27)		F(27)		G(20)			<u> </u>
	ZC		C(80)		C(80)		D(50)	D(50)	D8(30)		D8(30)		F(27)		F(27)		G(20)			<u> </u>
	ZK						C(80)		D(50)	D(50)			D8(30)			F(27)			G(20)	
25	ZKU							C(80)			D(50)			D8(30)						G(20)
	ZE														F(27)		G(20)			<u> </u>
	ZF												F (27)			G (20)				
	ZS		-4	- ()	- />		- ()		()		- ()		_ ()		- ()	- ()			G12(14)	G16(11)
	ZA		C(100)	D(60)			D(60)		D8(35)		F(27)		F(27)		G(20)	G(20)				—
	ZC	C(100)	C(100)		D(60)		D(60)		D8(35)		F(27)		F(27)	F(27)	G(20)	G(20)	C(20)			
35	ZK ZKU				C(100)	C(100)		D(60)	D(60)		D8(35)	D8(35)		F(27)	F(27)		G(20)	G(20)		
33	ZE					C(100)			D(00)			D6(33)	F(27)		1(27)	G(20)		G(20)		
	ZF										F (30)		G (23)			0(20)				
	ZS										(30)		()				G12(14)		G16(11)	
	ZA	C(120)	D(80)		D8(40)		F(30)		F(30)		G(28)						, ,			
	ZC		D(80)		D8(40)		F(30)		F(30)		G(28)	G(28)								
50	ZE								F(30)		G(28)									
	ZF							F (35)			G (28)									
	ZS												G12(17))	G16(13))				
	ZA	D(120)	D8(80)		F(40)		F(40)	G(30)	G(30)	G(30)										
	ZC	D(120)	D8(80)		F(40)		F(40)	G(30)	G(30)	G(30)										
63	ZE				F(40)			G(30)		G(30)										<u> </u>
	ZF				F (40)			G (30)												<u></u>
	ZS										G12(19))	G16(15))						<u> </u>
80	ZA		F(45)		G(36)															
	ZC		F(45)		G(36)		G(36)												(=05	

Size code (ESR $m\Omega$)

New

Size code			Unit : mm		
С	φ5 x L5.8	F	φ8 x L10.2	G16	φ10 x L16.5
D	φ6.3 x L5.8	G	φ10 x L10.2		_
D8	φ6.3 x L7.7	G12	φ10 x L12.5		

F	φ8 x L9.5
G	φ10 x L9.5

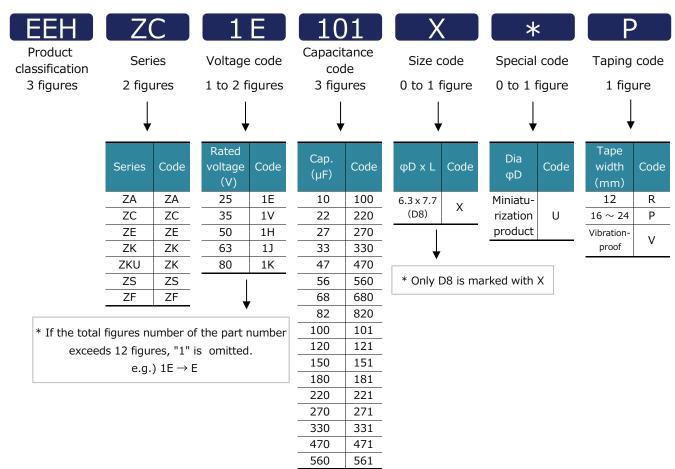
SMD type Radial lead type



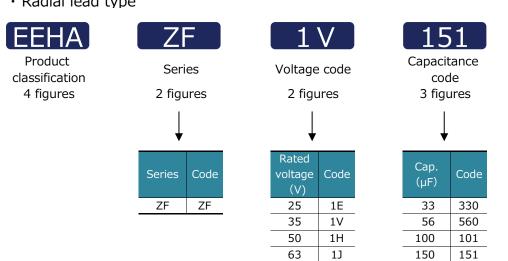
Explanation of part numbers

♦ Part number system

Surface mount type



Radial lead type



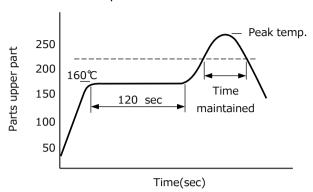
270

271

Mounting specification

Specifications for surface mount type

- Reflow guaranteed condition
 - < RoHS compliant >



Size code	C, D, D8	F, G, G	12, G16		
Peak temp.	260℃ (255℃)	245℃	260℃		
Time in peak	≧ 250°C 5 s	≥ 240°C 10 s	≧ 250°C 5 s		
temperature	(10 s)	≥ 240 C 10 S	= 230 C 3 S		
Time	≥ 230°C 30 s	≥ 230°C 30 s	≥ 230°C 30 s		
maintained	≥ 217°C 40 s	≥ 217°C 40 s	≥ 217°C 40 s		
mamameu	≥ 200°C 70 s	≥ 200°C 70 s	≥ 200°C 70 s		
Time of reflow	2 times	2 times	1 time		

- * For reflow, use a thermal condition system such as infrared and radiation (IR) or hot blas
- * Panasonic have several series available for pure Tin terminal ZVEI reflow based on J-STD-020D (JEDEC). (Please contact sales for details.)

Specifications for radial lead type

- Flow soldering condition
 - < RoHS compliant >

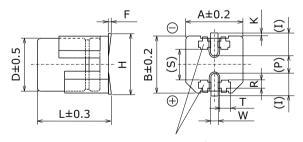
	Temperature	Time	Flow number
Soldering condition	260°C + 5°C or less	10 sec +1 sec or less	1 time

Vibration-proof products

The size and shape are different frome standard products.

Please inquire details of our company.

< Size code : D, D8 >

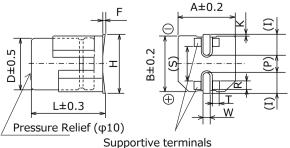


Supportive terminals
() Reference size

Unit: mm F Size code φD A, B H max. Ι W 2.4 6.3 6.1 6.6 7.8 0 to +0.15 0.65 ± 0.1 D D8 6.3 8.0 6.6 7.8 0 to +0.152.4 0.65 ± 0.1

Siz	ze code	Р	K		R	S	Т
	D	2.2	0.35	+0.15 -0.20	1.1±0.2	3.3	1.05±0.2
	D8	2.2	0.35	+0.15 -0.20	1.1±0.2	3.3	1.05±0.2

< Size code : F, G, G12, G16 >



	terriniais	JILIVE	ΟI
)Reference size	(

							Unit : mm
Size code	φD	L	A, B	H max.	F	I	W
H	8.0	10.5	8.3	10.0	0 to +0.15	3.4	1.2±0.2
O	10.0	10.5	10.3	12.0	0 to +0.15	3.5	1.2±0.2
G12	10.0	12.8	10.3	11.0*1	0 to +0.15	3.2	1.2±0.2
G16	10.0	16.8	10.3	11.0*1	0 to +0.15	3.2	1.2±0.2

Size code	Р	K	R	S	Т
Т	3.1	0.70±0.2	0.70±0.2	5.3	1.3±0.2
O	4.6	0.70±0.2	0.70±0.2	6.9	1.3±0.2
G12	4.6	_	0.70±0.2	6.9	1.3±0.2
G16	4.6	_	0.70±0.2	6.9	1.3±0.2

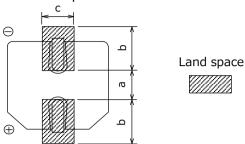


Mounting specification

Land / Pad pattern

The circuit board land/pad pattern size for chip capacitors is specified in the following table. The land pitch influences installation strength and consider it.

< Standard products >

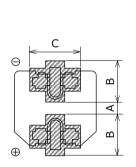


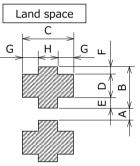
			Unit : mm
Size code	a	b	С
C : φ5×L5.8	1.5	2.8	1.6
D : φ6.3×L5.8	1.8	3.2	1.6
D8 : φ6.3×L7.7	1.8	3.2	1.6
F : φ8×L10.2	3.1	4.0	2.0
G : φ10×L10.2	4.6	4.1	2.0
G12: φ10×L12.5	4.6	4.1	2.0
G16: φ10×L16.5	4.6	4.1	2.0

When size "a" is wide, back fillet can be made, decreasing fitting strength.

* Take mounting conditions, solderability and fitting strength into consideration when selecting parts for your company's design.

< Vibration-proof products >

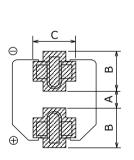


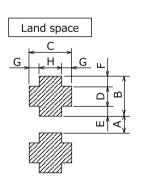


				Unit : mm
Size code	Α	В	С	D
D : φ6.3×L5.8	1.2	3.6	3.2	2.0
D8 : φ6.3×L7.7	1.2	3.6	3.2	2.0
	1		1	

Size code	Е	F	G	Н
D : φ6.3×L5.8	0.95	0.65	1.0	1.2
D8 : φ6.3×L7.7	0.95	0.65	1.0	1.2

When size "A" is wide, back fillet can be made, decreasing fitting strength.





				Unit : mm
Size code	Α	В	С	D
F : φ8×L10.2	2.7	4.0	4.7	1.3
G : φ10×L10.2	3.9	4.4	4.7	1.3
G12: φ10×L12.8	3.9	4.4	4.7	1.3
G16: φ10×L16.8	3.9	4.4	4.7	1.3

Size code	Е	F	G	Н
F : φ8×L10.2	1.0	1.7	1.1	2.5
G : φ10×L10.2	1.2	1.9	1.1	2.5
G12: φ10×L12.8	1.2	1.9	1.1	2.5
G16: φ10×L16.8	1.2	1.9	1.1	2.5

When size "A" is wide, back fillet can be made, decreasing fitting strength.

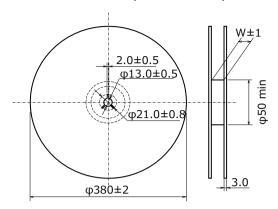
- * Take mounting conditions, solderability and fitting strength into consideration when selecting parts for your company's design.
- * The vibration-proof capacitors of size Φ6.3 has support terminals extending from the bottom side to the lead edge.

 Then, make sure to find appropriate soldering conditions to form fillet on the support terminals if required for appearance inspection.

Packaging specifications

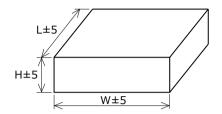
Specifications for surface mount type

• Reel dimensions (not to scale)



	Unit : mm
Size code	W
С	14.0
D, D8	18.0
F, G, G12, G16	26.0

Dimensions of outer carton box

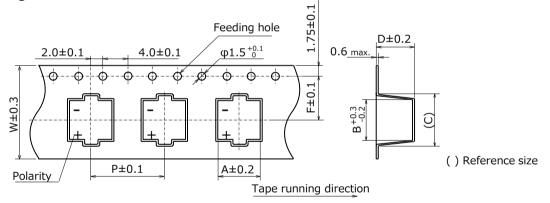


		Unit : mm
Size code	Н	W, L
С	220	395
D, D8	250	395
F, G, G12, G16	220	395

Min.packing quantity

Size code	Min.packing (pcs.)
C, D	1000
D8	900
F, G	500
G12	400
G16	250

• Taping dimensions



* Ask factory for technical specifications

							Unit : mm
Size code	Α	В	С	D	Р	F	W
С	5.7	5.7	8.0	6.4	12.0	5.5	12.0
D	7.0	7.0	9.0	6.4	12.0	7.5	16.0
D8	7.0	7.0	9.0	8.4	12.0	7.5	16.0
F	8.7	8.7	12.5	11.0	16.0	11.5	24.0
G	10.7	10.7	14.5	11.0	16.0	11.5	24.0
G12	10.7	10.7	14.5	13.7	16.0	11.5	24.0
G16	10.7	10.7	14.5	17.5	20.0	11.5	24.0

Specifications for radial lead type

Packing quantity

Size code	Quantity (pcs. / Bag)	Quantity (pcs. / Box)
F (φ8×L9.5)	200	4000
G (φ10×L9.5)	200	2000



UPGRADE

Surface Mount Type

V type **ZA** series

High temperature lead-free reflow



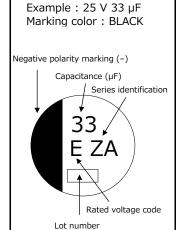
Hybrid

Features

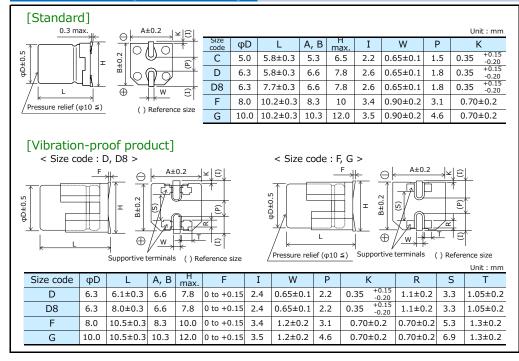
- Endurance : 10000 h at 105 ℃
- Low ESR and high ripple current (70 % over, Lower ESR than current V-FP)
- High voltage (to 80 V)
- Equivalent to conductive polymer type aluminum electrolytic capacitor (There are little characteristics change by temperature and frequency)
- Vibration-proof product is available upon request. New lineup of φ6.3 product. (φ6.3, φ8, φ10)
- AEC-Q200 compliant
- RoHS compliant

Specifications									
Size code	С		D	D8		F		G	
Category temp. range			-55 ℃ to +105 ℃						
Rated voltage range	25 V to 50 V		25 V t	o 63 V		25 ՝	V to 80 V		
Nominal cap.range	10 μF to 33 μF						33 µF to	330 μF	
Capacitance tolerance		±20 % (120 Hz / +20 ℃)							
DC leakage current		$I \leq 0.01 \text{ CV or } 3 \text{ (}\mu\text{A) After } 2 \text{ minutes (} \text{whichever is greater)}$							
Dissipation factor (tan δ)		Please see the attached characteristics list							
	+105 °C ± 2 °C, 100					exceeding the r	ated voltage.		
	Capacitance char			% of the initia					
	Dissipation factor (tan δ)		the initial lim					
Endurance	ESR	≤ 200 % of the initial limit							
Endurance	DC leakage curre	Within the initial limit							
	ESR after endurance		Size code						
				_		-	-		
CI IS IS							n being		
Shelf life			tors shall me	et the limits s	specified in	endurance.			
			0/ 2000	1 1 1	P 1				
D									
Damp neat (Load)		tan o)							
		ont							
		iy ariu ti	ien being sta	Dilizeu at +20	c, capac	litors stidii tileet	uie		
Resistance to		200	\M/i+hin ±100	/- of the initia	l value				
soldering heat					ii value				
_									
Shelf life Damp heat (Load) Resistance to soldering heat	stabilized at +20 °C, (With voltage treatn +85 °C ± 2 °C, 85 % Capacitance char Dissipation factor (1 ESR DC leakage curro	00 hour capaci nent) 6 to 90 nge tan δ) ent g and the	C D D8 F G 2.0 1.4 0.8 0.4 0.3 rs at +105 ℃ ± 2 ℃ with no voltage applied and then being citors shall meet the limits specified in endurance. %, 2000 h, rated voltage applied Within ±30% of the initial value ≤ 200 % of the initial limit ≤ 200 % of the initial limit Within the initial limit then being stabilized at +20 ℃, capacitors shall meet the Within ±10% of the initial value Within the initial limit Within the initial limit Within the initial limit Within the initial limit Within the initial limit						

Marking



R. voltage code	e Unit : V
Е	25
V	35
Н	50
J	63
K	80



ZA series

Characteristics list

Endurance : 105 ℃ 10000 h

		Case size (mm)				Spe	cificatio	n	Part n	umber	Min.packaging q'ty
Rated voltage (V)	Capacitance (±20 %) (μF)	φD	Standard	Vibration	Size code	Ripple current*1 (mA rms)	ESR ^{*2} (mΩ)	tan δ^{*3}	Standard Product	Vibration-proof product	Taping (pcs)
NE	w 22	5.0	5.8	-	С	900	80	0.14	EEHZA1E220R	-	1000
	33	5.0	5.8	-	С	900	80	0.14	EEHZA1E330R	-	1000
NE	w 47	6.3	5.8	6.1	D	1300	50	0.14	EEHZA1E470P	EEHZA1E470V	1000
	56	6.3	5.8	6.1	D	1300	50	0.14	EEHZA1E560P	EEHZA1E560V	1000
25 🔤	w 68	6.3	7.7	8.0	D8	2000	30	0.14	EEHZA1E680XP	EEHZA1E680XV	900
	100	6.3	7.7	8.0	D8	2000	30	0.14	EEHZA1E101XP	EEHZA1E101XV	900
NE	w 150	8.0	10.2	10.5	F	2300	27	0.14	EEHZA1E151P	EEHZA1E151V	500
	220	8.0	10.2	10.5	F	2300	27	0.14	EEHZA1E221P	EEHZA1E221V	500
	330	10.0	10.2	10.5	G	2500	20	0.14	EEHZA1E331P	EEHZA1E331V	500
NE	w 10	5.0	5.8	-	С	900	100	0.12	EEHZA1V100R	-	1000
	22	5.0	5.8	-	С	900	100	0.12	EEHZA1V220R	-	1000
	27	6.3	5.8	6.1	D	1300	60	0.12	EEHZA1V270P	EEHZA1V270V	1000
NE	w 33	6.3	5.8	6.1	D	1300	60	0.12	EEHZA1V330P	EEHZA1V330V	1000
35	47	6.3	5.8	6.1	D	1300	60	0.12	EEHZA1V470P	EEHZA1V470V	1000
35	68	6.3	7.7	8.0	D8	2000	35	0.12	EEHZA1V680XP	EEHZA1V680XV	900
NE	w 100	8.0	10.2	10.5	F	2300	27	0.12	EEHZA1V101P	EEHZA1V101V	500
	150	8.0	10.2	10.5	F	2300	27	0.12	EEHZA1V151P	EEHZA1V151V	500
NE		10.0	10.2	10.5	G	2500	20	0.12	EEHZA1V221P	EEHZA1V221V	500
	270	10.0	10.2	10.5	G	2500	20	0.12	EEHZA1V271P	EEHZA1V271V	500
	10	5.0	5.8	-	С	750	120	0.10	EEHZA1H100R	-	1000
	22	6.3	5.8	6.1	D	1100	80	0.10	EEHZA1H220P	EEHZA1H220V	1000
50 _	33	6.3	7.7	8.0	D8	1600	40	0.10	EEHZA1H330XP	EEHZA1H330XV	900
50 NE		8.0	10.2	10.5	F	1800	30	0.10	EEHZA1H470P	EEHZA1H470V	500
	68	8.0	10.2	10.5	F	1800	30	0.10	EEHZA1H680P	EEHZA1H680V	500
	100	10.0	10.2	10.5	G	2000	28	0.10	EEHZA1H101P	EEHZA1H101V	500
	10	6.3	5.8	6.1	D	1000	120	0.08	EEHZA1J100P	EEHZA1J100V	1000
	22	6.3	7.7	8.0	D8	1500	80	0.08	EEHZA1J220XP	EEHZA1J220XV	900
	33	8.0	10.2	10.5	F	1700	40	0.08	EEHZA1J330P	EEHZA1J330V	500
63 🔼		8.0	10.2	10.5	F	1700	40	0.08	EEHZA1J470P	EEHZA1J470V	500
	56	10.0	10.2	10.5	G	1800	30	0.08	EEHZA1J560P	EEHZA1J560V	500
NE		10.0	10.2	10.5	G	1800	30	0.08	EEHZA1J680P	EEHZA1J680V	500
NE		10.0	10.2	10.5	G	1800	30	0.08	EEHZA1J820P	EEHZA1J820V	500
80	22	8.0	10.2	10.5	F	1550	45	0.08	EEHZA1K220P	EEHZA1K220V	500
- 00	33	10.0	10.2	10.5	G	1700	36	0.08	EEHZA1K330P	EEHZA1K330V	500

^{*1:} Ripple current (100 kHz / +105 °C)

[♦] The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

Frequency co	rrection	factor for ripp	le current		
rrequeries co	of i Cotion	ractor for ripp	ie carreite		
Rated capacitance (C)	Frequency (f)	100 Hz ≦ f < 200 Hz	200 Hz ≤ f < 300 Hz	300 Hz ≦ f < 500 Hz	500 Hz ≦ f < 1 kHz
C < 47 µF	Correction	0.10	0.10	0.15	0.20
47 μF ≦ C < 150 μF		0.15	0.20	0.25	0.30
150 µF ≦ C	factor	0.15	0.25	0.25	0.30
		•			_
Rated capacitance (C)	Frequency (f)	1 kHz ≦ f < 2 kHz	$2 \text{ kHz} \leq f < 3 \text{ kHz}$	$3 \text{ kHz} \leq f < 5 \text{ kHz}$	5 kHz ≦ f < 10 kHz
C < 47 µF	Correction	0.30	0.40	0.45	0.50
47 μF ≦ C < 150 μF		0.40	0.45	0.55	0.60
150 µF ≦ C	factor	0.45	0.50	0.60	0.65
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≤ f < 30 kHz	$30 \text{ kHz} \le f < 40 \text{ kHz}$
C < 47 µF	Correction	0.60	0.65	0.70	0.75
47 μF ≦ C < 150 μF		0.70	0.75	0.80	0.80
150 µF ≦ C	factor	0.75	0.80	0.85	0.85
Rated capacitance (C)	Frequency (f)	40 kHz ≤ f < 50 kHz	$50 \text{ kHz} \le f < 100 \text{ kHz}$	100 kHz ≤ f < 500 kHz	500 kHz ≦ f
C < 47 µF	Correction	0.80	0.85	1.00	1.05
47 μF ≦ C < 150 μF		0.85	0.90	1.00	1.00
150 µF ≦ C	factor	0.85	0.90	1.00	1.00

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} tan δ (120 Hz / +20 °C)

[◆] Please refer to the page of "Reflow profile" and "The taping dimensions".



UPGRADE

Surface Mount Type

ZC series **V** type

High temperature lead-free reflow



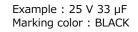
Hybrid

Features

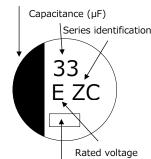
- Endurance: 4000 h at 125 ℃ (High temperature / Long life)
- Low ESR and high ripple current (85 % over, Lower ESR than current V-TP)
- High-withstand voltage (to 80 V), Low LC (0.01 CV or 3 μA)
 Equivalent to conductive polymer type aluminum electrolytic capacitor (There are little characteristics change by temperature and frequency)
- Vibration-proof product is available upon request. New lineup of ϕ 6.3 product. (ϕ 6.3, ϕ 8, ϕ 10)
- AEC-Q200 compliant
- RoHS compliant

Specifications						
Size code	С		D	D8	F	G
Category temp, range	'			-55 ℃ to +125 ℃		
Rated voltage range	25 V to 50 V		25 V t	:o 63 V	25 V t	to 80 V
Nominal cap.range	10 μF to 33 μF	10 μ	F to 56 µF	22 μF to 100 μF	22 μF to 220 μF	33 μF to 330 μF
Capacitance tolerance				20 % (120 Hz / +20 °		
DC leakage current		$I \leq 0.0$		A) After 2 minutes (w		
Dissipation factor (tan δ)				the attached charact		
				ripple current withou	t exceeding the rate	d voltage.
	Capacitance chan			% of the initial value		
Endurance 1	Dissipation factor (t	an δ)		the initial limit		
	ESR			the initial limit		
	DC leakage curre		Within the i			
			ply the rated	ripple current withou	it exceeding the rate	d voltage.
- I 0	Capacitance chan			% of the initial value		
Endurance 2	Dissipation factor (t	an o)		the initial limit		
	ESR			the initial limit		
	DC leakage curre		Within the i		P. L. Liller I	
CI IE 1:E-				± 2 °C with no voltag		being
Shelf life			itors snaii me	et the limits specified	in endurance.	
	(With voltage treatm		0/ 2000 h ==	atad valtaga applied		
	$+85 \% \pm 2 \%$, 85% Capacitance chan			% of the initial value		
Damp heat (Load)	Dissipation factor (t			the initial limit		
Darrip Heat (Load)	ESR	all 0)		the initial limit		
	DC leakage curre	nt	Within the i			
	After reflow soldering	a and t		ibilized at +20 ℃, cap	acitors shall meet th	16
Docieta non te	following limits.	g aria ti	incin beinig ste	15111200 at 120 0, cap	acitors silan friect tr	
Resistance to	Capacitance chan	ae	Within ±10	% of the initial value		
soldering heat	Dissipation factor (t		Within the i			
	DC leakage curre		Within the i			

Marking



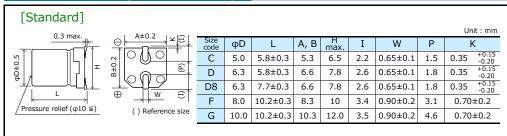
Negative polarity marking (-)



Lot number

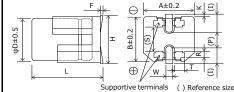
R. voltage code	e Unit : V
E	25
V	35
Н	50
J	63
K	80

Dimensions (not to scale)



[Vibration-proof product]

< Size code : D, D8 >



< Size code : F, G > Pressure relief (φ10 ≤) Supportive terminals

												Unit : mm
Size code	φD	L	A, B	H max.	F	I	W	Р	K	R	S	Т
О	6.3	6.1±0.3	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 +0.15 -0.20	1.1±0.2	3.3	1.05±0.2
D8	6.3	8.0±0.3	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 +0.15 -0.20	1.1±0.2	3.3	1.05±0.2
F	8.0	10.5±0.3	8.3	10.0	0 to +0.15	3.4	1.2±0.2	3.1	0.70±0.2	0.70±0.2	5.3	1.3±0.2
G	10.0	10.5±0.3	10.3	12.0	0 to +0.15	3.5	1.2±0.2	4.6	0.70±0.2	0.70±0.2	6.9	1.3±0.2

ZC series

Characteristics list

Endurance 1 : 125 $^{\circ}$ C 4000 h Endurance 2 : 125 $^{\circ}$ C 3000 h

		(Case size	е			Specif	ication		Part n	umber	Min. packaging
Rated voltage (V)	Capacitance (±20 %) (µF)	φD	ı	_	Size code		urrent *1 rms)	ESR*2	tan δ^{*3}	Standard	Vibration-proof	Taping
,	(μ.)	·	Standard	Vibration -proof		Endurance 1	Endurance 2	(mΩ)		Product	product	(pcs)
NE		5.0	5.8	-	С	550	_	80	0.14	EEHZC1E220R	_	1000
	33	5.0	5.8	-	С	550	-	80	0.14	EEHZC1E330R	_	1000
NE		6.3	5.8	6.1	D	900	_	50	0.14	EEHZC1E470P	EEHZC1E470V	1000
	56	6.3	5.8	6.1	D	900	-	50	0.14	EEHZC1E560P	EEHZC1E560V	1000
25 🔤		6.3	7.7	8.0	D8	1400	_	30	0.14	EEHZC1E680XP	EEHZC1E680XV	900
	100	6.3	7.7	8.0	D8	1400	-	30	0.14	EEHZC1E101XP	EEHZC1E101XV	900
NE	w 150	8.0	10.2	10.5	F	1600	1900	27	0.14	EEHZC1E151P	EEHZC1E151V	500
	220	8.0	10.2	10.5	F	1600	1900	27	0.14	EEHZC1E221P	EEHZC1E221V	500
	330	10.0	10.2	10.5	G	2000	2900	20	0.14	EEHZC1E331P	EEHZC1E331V	500
NE		5.0	5.8	-	С	550	_	100	0.12	EEHZC1V100R	_	1000
	22	5.0	5.8	-	С	550	-	100	0.12	EEHZC1V220R	-	1000
NE		6.3	5.8	6.1	D	900	_	60	0.12	EEHZC1V330P	EEHZC1V330V	1000
	47	6.3	5.8	6.1	D	900	-	60	0.12	EEHZC1V470P	EEHZC1V470V	1000
35	68	6.3	7.7	8.0	D8	1400	-	35	0.12	EEHZC1V680XP	EEHZC1V680XV	900
NE		8.0	10.2	10.5	F	1600	1900	27	0.12	EEHZC1V101P	EEHZC1V101V	500
	150	8.0	10.2	10.5	F	1600	1900	27	0.12	EEHZC1V151P	EEHZC1V151V	500
NE	w 220	10.0	10.2	10.5	G	2000	2800	20	0.12	EEHZC1V221P	EEHZC1V221V	500
	270	10.0	10.2	10.5	G	2000	2800	20	0.12	EEHZC1V271P	EEHZC1V271V	500
	10	5.0	5.8	-	С	500	-	120	0.10	EEHZC1H100R	-	1000
	22	6.3	5.8	6.1	D	750	-	80	0.10	EEHZC1H220P	EEHZC1H220V	1000
	33	6.3	7.7	8.0	D8	1100	-	40	0.10	EEHZC1H330XP	EEHZC1H330XV	900
50 🔤		8.0	10.2	10.5	F	1250	_	30	0.10	EEHZC1H470P	EEHZC1H470V	500
	68	8.0	10.2	10.5	F	1250	-	30	0.10	EEHZC1H680P	EEHZC1H680V	500
	100	10.0	10.2	10.5	G	1600	-	28	0.10	EEHZC1H101P	EEHZC1H101V	500
	120	10.0	10.2	10.5	G	1600	-	28	0.10	EEHZC1H121P	EEHZC1H121V	500
	10	6.3	5.8	6.1	D	700	-	120	0.08	EEHZC1J100P	EEHZC1J100V	1000
	22	6.3	7.7	8.0	D8	900	-	80	0.08	EEHZC1J220XP	EEHZC1J220XV	900
	33	8.0	10.2	10.5	F	1100	-	40	0.08	EEHZC1J330P	EEHZC1J330V	500
63	47	8.0	10.2	10.5	F	1100	-	40	0.08	EEHZC1J470P	EEHZC1J470V	500
	56	10.0	10.2	10.5	G	1400	-	30	0.08	EEHZC1J560P	EEHZC1J560V	500
	68	10.0	10.2	10.5	G	1400	-	30	0.08	EEHZC1J680P	EEHZC1J680V	500
	82	10.0	10.2	10.5	G	1400	-	30	0.08	EEHZC1J820P	EEHZC1J820V	500
	22	8.0	10.2	10.5	F	1050	-	45	0.08	EEHZC1K220P	EEHZC1K220V	500
80	33	10.0	10.2	10.5	G	1360	-	36	80.0	EEHZC1K330P	EEHZC1K330V	500
	47	10.0	10.2	10.5	G	1360	_	36	0.08	EEHZC1K470P	EEHZC1K470V	500

^{*1:} Ripple current (100 kHz / +125 ℃)

lacktriangle The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

Frequency co	Frequency correction factor for ripple current							
Rated capacitance (C)	Frequency (f)	100 Hz ≤ f < 200 Hz	200 Hz ≤ f < 300 Hz	300 Hz ≤ f < 500 Hz	500 Hz ≦ f < 1 kHz			
C < 47 µF	Correction	0.10	0.10	0.15	0.20			
47 μF ≦ C < 150 μF		0.15	0.20	0.25	0.30			
150 μF ≦ C	factor	0.15	0.25	0.25	0.30			
Dated canacitance (C)	Fraguency (f)	1 kHz ≦ f < 2 kHz	2 l/Uz < f < 2 l/Uz	3 kHz ≦ f < 5 kHz	E 1/47 < f < 10 1/47			
	Frequency (f)		2 kHz ≤ f < 3 kHz		5 kHz ≤ f < 10 kHz			
C < 47 µF	Correction	0.30	0.40	0.45	0.50			
47 μF ≦ C < 150 μF	6t	0.40	0.45	0.55	0.60			
150 μF ≦ C	factor	0.45	0.50	0.60	0.65			
- · · · · · · · · · · · · · · · · · · ·	- (0							
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≤ f < 30 kHz	30 kHz ≤ f < 40 kHz			
C < 47 µF	Correction	0.60	0.65	0.70	0.75			
47 μF ≦ C < 150 μF		0.70	0.75	0.80	0.80			
150 μF ≦ C	factor	0.75	0.80	0.85	0.85			
2	- (6)	40 111 6 5 50 111	50 111 26 400 111	100 111 16 500 111	500 111 4 6			
	Frequency (f)		50 kHz ≤ f < 100 kHz	100 kHz ≤ f < 500 kHz	500 kHz ≦ f			
C < 47 μF	Correction	0.80	0.85	1.00	1.05			
47 μF ≦ C < 150 μF		0.85	0.90	1.00	1.00			
150 μF ≦ C	factor	0.85	0.90	1.00	1.00			

After (After endurance ESR (100 kHz, -40 °C)									
Size	φ5 x L5.8	φ6.3 x L5.8	φ6.3 x L7.7	φ8 x L10.2	φ10 x L10.2					
ESR (Ω)	2	1.4	0.8	0.4	0.3					

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} tan δ (120 Hz / +20 °C)

[◆] Please refer to the page of "Reflow profile" and "The taping dimensions".



UPGRADE

Surface Mount Type

ZK series **V** type

High temperature lead-free reflow



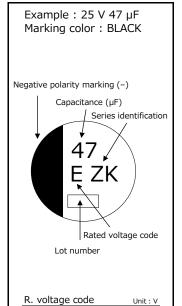
Hybrid

Features

- High capacitance and High ripple current compared with ZC series
- Endurance : 4000 h at 125 °C (High temperature / Long life)
- Low ESR (85 % over, Lower ESR than Current V-TP), Low LC (0.01 CV or 3 μA)
- Equivalent to conductive polymer type Aluminum Electrolytic Capacitor (There are little characteristics change by temperature and frequency)
- Vibration-proof product is available upon request. New lineup of φ6.3 product. (φ6.3, φ8, φ10)
- AEC-Q200 compliant
- RoHS compliant

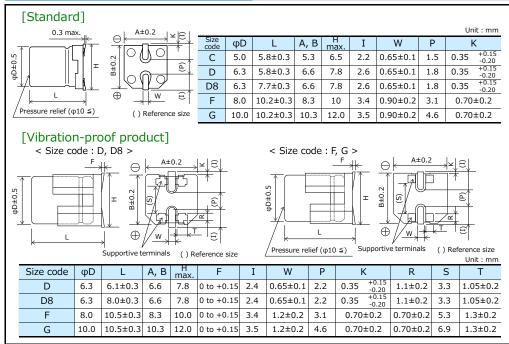
Specifications										
Size code	С	D	D8		F	(G			
Category temp. range			-55 ℃ to +	125 ℃						
Rated voltage range			25 V to 3	5 V						
Nominal cap.range	33 μF to 47 μF 5	6 μF to 82 μF	100 μF to 1	50 μF 18	30 μF to 270 μF	330 µF t	o 470 µF			
Capacitance tolerance			20 % (120 Hz							
DC leakage current	I ≦	0.01 CV or 3 (µ)				
Dissipation factor (tan δ)			the attached							
	+125 ℃ ± 2 ℃, 4000 h,				ceeding the rat	ed voltage.				
	Capacitance change		% of the initia							
	Dissipation factor (tan à		the initial lim							
Endurance	ESR		the initial lim	it						
Lituarance	DC leakage current	Within the i	Within the initial limit							
	ESR after endurance			Size code						
	(Ω / 100 kHz)(-40 °C)	С	D	D8	F	G				
	, ,	2.0	1.4	0.8	0.4	0.3				
	After storage for 1000 h					being				
Shelf life	stabilized at +20 ℃, cap		et the limits sp	pecified in e	ndurance.					
	(With voltage treatment									
	+85									
	Capacitance change		Within ±30% of the initial value							
Damp heat (Load)	Dissipation factor (tan à		≤ 200 % of the initial limit							
	ESR		≤ 200 % of the initial limit							
	DC leakage current	Within the i								
	After reflow soldering an	id then being sta	abilized at +20	°C, capaci	tors shall meet	the				
Resistance to	following limits.) M': L : L 4 0	0/ (1)	1 1						
soldering heat	Capacitance change		% of the initia	i value						
Sold Ching Tiede	Dissipation factor (tan à									
	DC leakage current	Within the i	nıtıal lımıt							

Marking



25

35



ZK series

Characteristics list

Endurance : 125 ℃ 4000 h

		(Case size	е		Spe	cificatio	n	Part n	Min.packaging q'ty	
Rated voltage	Capacitance (±20 %)		I	L	Size	Ripple	urrent ^{*1} $\frac{ESR^{-1}}{(m\Omega)}$ tan δ^{*3}		Standard	Vibration-proof	Taping
(V)	(µF)	φD	Standard	Vibration -proof	code	current*1 (mA rms)			nt^{-1} (m Ω) Call 0 Product product		
	47	5.0	5.8	-	С	850	80	0.14	EEHZK1E470R	_	1000
	68	6.3	5.8	6.1	D	1300	50	0.14	EEHZK1E680P	EEHZK1E680V	1000
25	w 82	6.3	5.8	6.1	D	1300	50	0.14	EEHZK1E820P	EEHZK1E820V	1000
23	150	6.3	7.7	8.0	D8	1800	30	0.14	EEHZK1E151XP	EEHZK1E151XV	900
	270	8.0	10.2	10.5	F	2000	27	0.14	EEHZK1E271P	EEHZK1E271V	500
	470	10.0	10.2	10.5	G	2800	20	0.14	EEHZK1E471P	EEHZK1E471V	500
	33	5.0	5.8	-	С	750	100	0.12	EEHZK1V330R	_	1000
	56	6.3	5.8	6.1	D	1200	60	0.12	EEHZK1V560P	EEHZK1V560V	1000
35	100	6.3	7.7	8.0	D8	1700	35	0.12	EEHZK1V101XP	EEHZK1V101XV	900
	180	8.0	10.2	10.5	F	2000	27	0.12	EEHZK1V181P	EEHZK1V181V	500
	330	10.0	10.2	10.5	G	2800	20	0.12	EEHZK1V331P	EEHZK1V331V	500

^{*1:} Ripple current (100 kHz $/ +125 \degree$ C)

[♦] The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

Frequency co	orrection	factor for ripp	le current			
Rated capacitance (C)	Frequency (f)	100 Hz ≤ f < 200 Hz	200 Hz ≤ f < 300 Hz	300 Hz ≤ f < 500 Hz	500 Hz ≤ f < 1 kHz	
C < 47 μF	C	0.15	0.20	0.25	0.35	
47 μF ≦ C < 100 μF	Correction factor	0.15	0.25	0.30	0.40	
100 μF ≦ C	lactor	0.15	0.25	0.30	0.40	
Rated capacitance (C)	Frequency (f)	1 kHz ≦ f < 2 kHz	2 kHz ≦ f < 3 kHz	3 kHz ≦ f < 5 kHz	5 kHz ≦ f < 10 kHz	
C < 47 µF	C	0.45	0.55	0.60	0.65	
47 μF ≦ C < 100 μF	Correction factor	0.50	0.60	0.65	0.70	
100 μF ≦ C	lactor	0.50	0.60	0.65	0.70	
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≤ f < 30 kHz	30 kHz ≦ f < 40 kHz	
C < 47 µF	C	0.70	0.75	0.75	0.75	
47 μF ≦ C < 100 μF	Correction factor	0.75	0.75	0.80	0.80	
100 μF ≦ C	lactor	0.75	0.80	0.85	0.85	
Rated capacitance (C)	Frequency (f)	40 kHz ≦ f < 50 kHz	50 kHz ≦ f < 100 kHz	100 kHz ≦ f < 500 kHz	500 kHz ≦ f	
C < 47 µF	C	0.80	0.85	1.00	1.05	
47 μF ≦ C < 100 μF	Correction factor	0.85	0.90	1.00	1.00	
100 μF ≦ C	iactor	0.85	0.90	1.00	1.00	

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} tan δ (120 Hz / +20 °C)

[◆] Please refer to the page of "Reflow profile" and "The taping dimensions".





Surface Mount Type

ZKU series **V** type

High temperature lead-free reflow



Hybrid

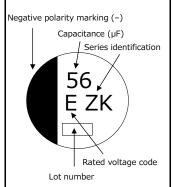
Features

- Endurance: 4000 h at 125 ℃ (High temperature / Long life)
- Large capacitance compared with ZK series
- Low ESR (85 % over, Lower ESR than Current V-TP), Low LC (0.01 CV or 3 μA)
- Equivalent to conductive polymer type Aluminum Electrolytic Capacitor (There are little characteristics change by temperature and frequency)
- Vibration-proof product is available upon request. (ϕ 6.3, ϕ 8, ϕ 10)
- AEC-Q200 compliant
- RoHS compliant

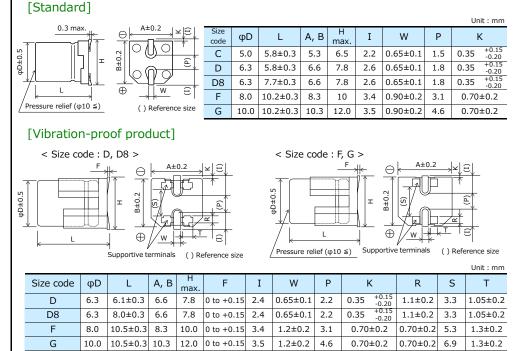
Specifications									
Size code	С		D	D8			F		G
Category temp. range				-55 ℃ to +	125 ℃				
Rated voltage range				25 V to 3	5 V				_
Nominal cap.range	39 μF to 56 μF	68 µF	to 100 μF	120 μF to 1	80 μF	220 μF t	ο 330 μF	390 µF	to 560 µF
Capacitance tolerance			±2	20 % (120 Hz	/ +20 ℃	C)			
DC leakage current		$I \leq 0.0$)1 CV or 3 (μ.	A) After 2 mir	nutes (wh	nichever i	s greater)	
Dissipation factor (tan δ)				the attached					
	+125 °C ± 2 °C 4000					exceedin	g the rate	ed voltage.	
	Capacitance chan	Within ±309	% of the initia	l value					
	Dissipation factor (ta	≤ 200 % of the initial limit							
Endurance	ESR	≤ 200 % of	the initial lim	it					
Litatiance	DC leakage curre	nt	Within the in	nitial limit					
	ESR after endurance		Size code						
	(Ω / 100 kHz)(-40 °			D	D8		F	G	
	, ,		2.0	1.4	0.8		0.4	0.3	
	After storage for 100							being	
Shelf life	stabilized at +20 ℃,		ors shall mee	et the limits sp	pecified in	n endurar	ice.		
	(With voltage treatme								
	+85 °C ± 2 °C, 85 %				<u> </u>				
	Capacitance chan			% of the initia					
Damp heat (Load)	Dissipation factor (ta	an δ)		the initial lim					
	ESR			the initial lim	it				
	DC leakage curre	nt	Within the in	nitial limit					

Marking

Example: 25 V 56 μF Marking color: BLACK



R. voltage code	Onit : V
E	25
V	35



ZKU series

Characteristics list

Endurance : 125 ℃ 4000 h

	Capacitance (±20 %) (µF)	Case size (mm)			Spe	ecificatio	n	Part n	umber	Min.packaging q'ty	
Rated voltage (V)		φD	Standard	Vibration -proof	Size code	Ripple current*1 (mA rms)	ESR ^{*2} (mΩ)	tan δ ^{*3}	Standard Product	Vibration-proof product	Taping (pcs)
	56	5	5.8	-	С	850	80	0.14	EEHZK1E560UR	-	1000
	100	6.3	5.8	6.1	D	1300	50	0.14	EEHZK1E101UP	EEHZK1E101UV	1000
25	180	6.3	7.7	8.0	D8	1800	30	0.14	EEHZKE181XUP	EEHZKE181XUV	900
	330	8	10.2	10.5	F	2000	27	0.14	EEHZK1E331UP	EEHZK1E331UV	500
	560	10	10.2	10.5	G	2800	20	0.14	EEHZK1E561UP	EEHZK1E561UV	500
	39	5	5.8	-	С	750	100	0.12	EEHZK1V390UR	-	1000
	68	6.3	5.8	6.1	D	1200	60	0.12	EEHZK1V680UP	EEHZK1V680UV	1000
35	120	6.3	7.7	8.0	D8	1700	35	0.12	EEHZKV121XUP	EEHZKV121XUV	900
	220	8	10.2	10.5	F	2000	27	0.12	EEHZK1V221UP	EEHZK1V221UV	500
	390	10	10.2	10.5	G	2800	20	0.12	EEHZK1V391UP	EEHZK1V391UV	500

^{*1:} Ripple current (100 kHz / +125 ℃)

[♦] The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

Frequency co	orrection	factor for ripp	le current		
Rated capacitance (C)	Frequency(f)	100 Hz ≤ f < 200 Hz	200 Hz ≦ f < 300 Hz	300 Hz ≦ f < 500 Hz	500 Hz ≦ f < 1 kHz
C < 47 µF	C	0.15	0.20	0.25	0.35
47 μF ≦ C < 100 μF	Correction factor	0.15	0.25	0.30	0.40
100 µF ≦ C	lactor	0.15	0.25	0.30	0.40
Rated capacitance (C)	Frequency(f)	$1 \text{ kHz} \le f < 2 \text{ kHz}$	$2 \text{ kHz} \le f < 3 \text{ kHz}$	3 kHz ≦ f < 5 kHz	5 kHz ≦ f < 10 kHz
C < 47 µF	C	0.45	0.55	0.60	0.65
47 μF ≦ C < 100 μF	Correction factor	0.50	0.60	0.65	0.70
100 μF ≦ C	lactor	0.50	0.60	0.65	0.70
Rated capacitance (C)	Frequency(f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≦ f < 30 kHz	30 kHz ≦ f < 40 kHz
C < 47 µF	C	0.70	0.75	0.75	0.75
47 μF ≦ C < 100 μF	Correction factor	0.75	0.75	0.80	0.80
100 μF ≦ C	ractor	0.75	0.80	0.85	0.85
Rated capacitance (C)	Frequency(f)	40 kHz ≦ f < 50 kHz	50 kHz ≦ f < 100 kHz	100 kHz ≤ f < 500 kHz	500 kHz ≦ f
C < 47 μF	C	0.80	0.85	1.00	1.05
47 μF ≦ C < 100 μF	Correction factor	0.85	0.90	1.00	1.00
100 μF ≦ C	iactoi	0.85	0.90	1.00	1.00

^{*2:} ESR (100 kHz / +20 °C) *3: $\tan \delta$ (120 Hz / +20 °C)

[◆] Please refer to the page of "Reflow profile" and "The taping dimensions".



UPGRADE

Surface Mount Type

ZE series **V** type

High temperature lead-free reflow



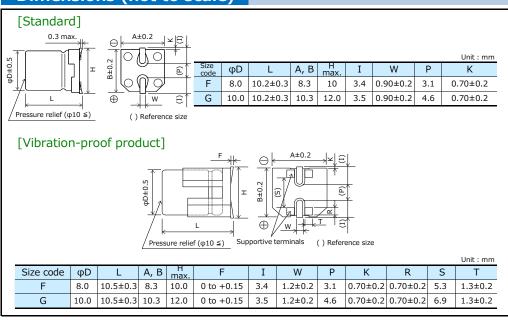
Features

- Endurance: 2000 h at 145 ℃ (High temperature / Long life)
- Low ESR and high ripple current (85 % over, Lower ESR than current V-TP)
- \bullet High-withstand voltage (to 63 V), Low LC (0.01 CV or 3 μ A)
- Equivalent to conductive polymer type aluminum electrolytic capacitor (There are little characteristics change by temperature and frequency)
- Vibration-proof product is available upon request. (φ8 mm and larger)
- AEC-Q200 compliant
- RoHS compliant

Specifications							
Size code	F		G				
Category temp. range	−55 ℃ to +145 ℃						
Rated voltage range	25 V to 63 V						
Nominal cap.range	33 μF to 2		56 μF to 330 μF				
Capacitance tolerance		±20 % (120	Hz / +20 ℃)				
DC leakage current	I ≤ 0.0		minutes (whichever is greater)				
Dissipation factor (tan δ)			ned characteristics list				
	+145 ℃ ± 2 ℃, 2000 h, ap		ent without exceeding the rated voltage				
	Capacitance change	Within ±30% of the in					
Endurance 1	Dissipation factor (tan δ)	≤ 200 % of the initial	-				
	E.S.R.	≤ 200 % of the initial	limit				
	DC leakage current	Within the initial limit					
	+135		ent without exceeding the rated voltage				
	Capacitance change	Within ±30% of the in					
Endurance 2	Dissipation factor (tan δ)	≤ 200 % of the initial					
	E.S.R.	≤ 200 % of the initial	limit				
	DC leakage current Within the initial limit						
	After storage for 1000 hours at $\pm 145 ^{\circ}$ $\pm 2 ^{\circ}$ with no voltage applied and then being						
Shelf life	stabilized at $+20$ °C, capacitors shall meet the limits specified in endurance 1.						
	(With voltage treatment)						
	85 $^{\circ}$ ± 2 $^{\circ}$, 85 $^{\circ}$ to 90 $^{\circ}$, 2000 h, rated voltage	applied				
Damp heat	Capacitance change	Within ±30% of the in					
· ·	Dissipation factor (tan δ)	≤ 200 % of the initial					
(Load)	E.S.R.	≤ 200 % of the initial	limit				
	DC leakage current	Within the initial limit					
		nen being stabilized at -	+20 ℃, capacitors shall meet the				
Resistance to	following limits.						
soldering heat	Capacitance change	Within ±10% of the in	itial value				
solueilig fleat	Dissipation factor (tan δ)	Within the initial limit					
	DC leakage current	Within the initial limit					

Marking

Example: 25 V 220 µF Marking color: BLACK Negative polarity marking (-) Capacitance (uF) Series identification Rated voltage code R. voltage code Unit : V Е 25 ν 35 Н 50



ZE series

Characteristics list

Endurance 1 : 145 $^{\circ}$ C 2000 h Endurance 2 : 135 $^{\circ}$ C 4000 h

Rated Capacitance voltage (±20 %)		Case size (mm)					Specif	ication		Part n	Min. packaging	
		φD	l	L			urrent *1 rms)	ESR*2	_*2		Vibration-proof	q'ty
(V)	(V) (µF)		Standard	Vibration	code	Endurance 1	Endurance 2	$(m\Omega)$ tan δ^*	tan δ ^{*3}	Standard product	product	Taping
		-proof			(+145℃)	(+135℃)					(pcs)	
25	220	8.0	10.2	10.5	F	700	1600	27	0.14	EEHZE1E221P	EEHZE1E221V	500
25	330	10.0	10.2	10.5	G	900	2000	20	0.14	EEHZE1E331P	EEHZE1E331V	500
25	150	150 8.0 10.2 10.5 F		F	700	1600	27	0.12	EEHZE1V151P	EEHZE1V151V	500	
35	270	10.0	10.2	10.5	G	900	2000	20	0.12	EEHZE1V271P	EEHZE1V271V	500
	68	8.0	10.2	10.5	F	600	1250	30	0.10	EEHZE1H680P	EEHZE1H680V	500
50	100	10.0	10.2	10.5	G	800	1600	28	0.10	EEHZE1H101P	EEHZE1H101V	500
	33	8.0	10.2	10.5	F	600	1100	40	0.08	EEHZE1J330P	EEHZE1J330V	500
63	56	10.0	10.2	10.5	G	800	1400	30	0.08	EEHZE1J560P	EEHZE1J560V	500
N	w 82	10.0	10.2	10.5	G	800	1400	30	0.08	EEHZE1J820P	EEHZE1J820V	500

^{*1:} Ripple current (100 kHz $/ +145 \,^{\circ}$ C or $+135 \,^{\circ}$ C)

[◆] The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

The difficultions of the vibration proof products, please refer to the page of the mountaing specimeation.										
Frequency c	Frequency correction factor for ripple current									
Rated capacitance (C)	Frequency (f)	100 Hz ≦ f < 200 Hz	200 Hz ≦ f < 300 Hz	300 Hz ≦ f < 500 Hz	500 Hz ≦ f < 1 kHz					
C < 47 μF	Compostion	0.10	0.10	0.15	0.20					
47 μF ≦ C < 150 μF	Correction factor	0.15	0.20	0.25	0.30					
150 μF ≦ C	Tactor	0.15	0.25	0.25	0.30					
Rated capacitance (C)	Frequency (f)	1 kHz ≦ f < 2 kHz	2 kHz ≦ f < 3 kHz	3 kHz ≦ f < 5 kHz	5 kHz ≦ f < 10 kHz					
C < 47 µF	Correction	0.30	0.40	0.45	0.50					
47 μF ≦ C < 150 μF	factor	0.40	0.45	0.55	0.60					
150 μF ≦ C	Tactor	0.45	0.50	0.60	0.65					
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≤ f < 20 kHz	20 kHz ≤ f < 30 kHz	30 kHz ≦ f < 40 kHz					
$C < 47 \mu F$	Correction	0.60	0.65	0.70	0.75					
47 μF ≦ C < 150 μF	factor	0.70	0.75	0.80	0.80					
150 μF ≦ C	Tactor	0.75	0.80	0.85	0.85					
Rated capacitance (C)	Frequency (f)	40 kHz ≦ f < 50 kHz	50 kHz ≦ f < 100 kHz	100 kHz ≤ f < 500 kHz	500 kHz ≦ f					
C < 47 μF	Correction	0.80	0.85	1.00	1.05					
47 μF ≦ C < 150 μF	factor	0.85	0.90	1.00	1.00					
150 μF ≦ C	iactoi	0.85	0.90	1.00	1.00					

After endurance ESR (100 kHz, -40°C)

Size	φ8 x L10.2	φ10 x L10.2
ESR (Ω)	0.4	0.3

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} tan δ (120 Hz / +20 °C)

[◆] Please refer to the page of "Reflow profile" and "The taping dimensions".



UPGRADE

Surface Mount Type

ZS series **V** type

High temperature lead-free reflow



Hybrid

Features

- Endurance: 4000 h at 125 ℃
- High ripple current and High capacitance
- \bullet High-withstand voltage (to 63 V), Low leakage current (0.01 CV or 3 μ F)
- Vibration-proof product is available upon request.
- AEC-Q200 compliant
- RoHS compliant

•							
Specifications							
Size code	G12		G16				
Category temp. range		-55	℃ to +125 ℃				
Rated voltage range		2	5 V to 63 V				
Nominal cap.range	100 μF to 4			150 μF to 560 μF			
Capacitance tolerance			(120 Hz / +20 °C)				
DC leakage current	I ≤ 0.0	01 CV or 3 (μA) Aft					
Dissipation factor (tan δ)	Please see the attached characteristics list						
	$+125$ $^{\circ}$ C \pm 2 $^{\circ}$ C, 4000 h, ap			exceeding the rated voltage.			
	Capacitance change	Within ±30% of the initial value					
	Dissipation factor (tan δ)	≤ 200 % of the ir					
Endurance	E.S.R.	≤ 200 % of the ir	nitial limit				
Litatiance	DC leakage current	Within the initial	limit				
	ESR after endurance	Size	code				
		G12	G16				
	(Ω / 100 kHz)(-40 °C)	0.3	0.3				
	After storage for 1000 hours at $+125~\%~\pm~2~\%$ with no voltage applied and then being						
Shelf life	stabilized at +20°C, capacitors shall meet the limits specified in endurance.						
	(With voltage treatment)						
	+85	%, 2000 h, rated \	oltage applied.				
Damp heat	Capacitance change	Within ±30% of t					
	Dissipation factor (tan δ)	≤ 200 % of the ir	nitial limit				
(Load)	E.S.R.	≤ 200 % of the ir					
	DC leakage current	Within the initial					
	After reflow soldering and t	hen being stabilize	d at +20℃, capac	itors shall meet the			
Resistance to	following limits.						
	Capacitance change	Within ±10% of t					
soldering heat	Dissipation factor (tan δ)	Within the initial					
	DC leakage current	Within the initial I	limit				

Marking

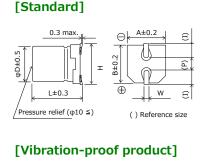
Example : 35 V 470 μF Marking color: BLACK Negative polarity marking (-) Capacitance (µF) Series identification Rated voltage code Lot number R. voltage code 25 Ε

35

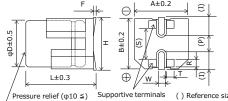
50 63

V

Н



Size code φD L A, B H I	V P
G12 10.0 12.5 10.3 11.0±0.2 3.2 1.2	±0.2 4.6
G16 10.0 16.5 10.3 11.0±0.2 3.2 1.2	±0.2 4.6



											Unit : mm
Size code	φD	L	A, B	Н	F	I	W	Р	R	S	Т
G12	10.0	12.8	10.3	11.0±0.2	0 to +0.15	3.2	1.2±0.2	4.6	0.70±0.2	6.9	1.3±0.2
G16	10.0	16.8	10.3	11.0±0.2	0 to +0.15	3.2	1.2±0.2	4.6	0.70±0.2	6.9	1.3±0.2

ZS series

Characteristics list

Endurance : 125 ℃ 4000 h

		Case size (mm)				Spe	cificatio	n	Part n	Min.packaging q'ty	
voltage (±	Capacitance (±20 %) (µF)	φD	Standard	Vibration -proof	Size code	Ripple current*1 (mA rms)	ESR ^{*2} (mΩ)	tan δ ^{*3}	Standard Product	Vibration-proof product	Taping (pcs)
 25	w 470	10.0	12.5	12.8	G12	3500	14	0.14	EEHZS1E471P	EEHZS1E471V	400
25	560	10.0	16.5	16.8	G16	4000	11	0.14	EEHZS1E561P	EEHZS1E561V	250
35	w 330	10.0	12.5	12.8	G12	3500	14	0.12	EEHZS1V331P	EEHZS1V331V	400
33	470	10.0	16.5	16.8	G16	4000	11	0.12	EEHZS1V471P	EEHZS1V471V	250
50	w 150	10.0	12.5	12.8	G12	3200	17	0.10	EEHZS1H151P	EEHZS1H151V	400
30	220	10.0	16.5	16.8	G16	3700	13	0.10	EEHZS1H221P	EEHZS1H221V	250
63	w 100	10.0	12.5	12.8	G12	3000	19	0.08	EEHZS1J101P	EEHZS1J101V	400
	150	10.0	16.5	16.8	G16	3500	15	0.08	EEHZS1J151P	EEHZS1J151V	250

^{*1:} Ripple current (100 kHz $/ +125 \degree$ C)

[◆] Please refer to the page of "Reflow profile" and "The taping dimensions".

Frequency c	Frequency correction factor for ripple current										
Rated capacitance (C)	Frequency (f)	100 Hz ≤ f < 200 Hz	200 Hz ≤ f < 300 Hz	300 Hz ≤ f < 500 Hz	500 Hz ≦ f < 1 kHz						
100 μF ≦ C < 150 μF	Correction	0.15	0.20	0.25	0.30						
150 µF ≦ C	factor	0.15	0.25	0.25	0.30						
Rated capacitance (C)	Frequency (f)	1 kHz ≦ f < 2 kHz	2 kHz ≦ f < 3 kHz	3 kHz ≤ f < 5 kHz	5 kHz ≦ f < 10 kHz						
$100 \ \mu\text{F} \le C < 150 \ \mu\text{F}$	Correction	0.40	0.45	0.55	0.60						
150 μF ≦ C	factor	0.45	0.50	0.60	0.65						
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≦ f < 30 kHz	30 kHz ≦ f < 40 kHz						
100 μF ≦ C < 150 μF	Correction	0.70	0.75	0.80	0.80						
150 μF ≦ C	factor	0.75	0.80	0.85	0.85						
Rated capacitance (C)	Frequency (f)	40 kHz ≦ f < 50 kHz	50 kHz ≦ f < 100 kHz	100 kHz ≦ f < 500 kHz	500 kHz ≦ f						
100 μF ≦ C < 150 μF	Correction	0.85	0.90	1.00	1.00						
150 μF ≦ C	factor	0.85	0.90	1.00	1.00						

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} tan δ (120 Hz / +20 °C)





Surface Mount Type

ZF series **V** type

High temperature lead-free reflow



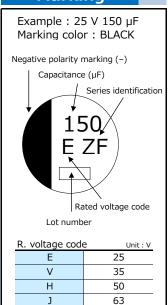


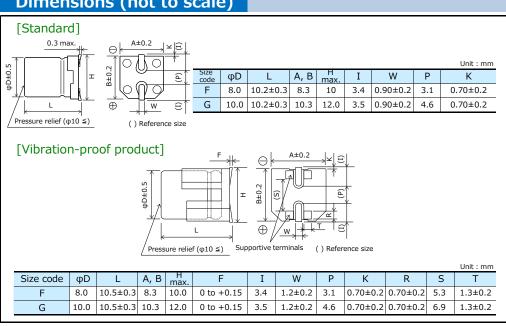
Features

- Endurance : 1000 h at 150 ℃ (High temperature)
- Low ESR and high ripple current
- \bullet High-withstand voltage (to 63 V), Low LC (0.01 CV or 3 μ A)
- Vibration-proof product is available upon request
- AEC-Q200 compliant
- RoHS compliant

Specifications									
Size code	F			G					
Category temp. range		-55 ℃ to	to +150 ℃						
Rated voltage range		25 V t	o 63 V						
Nominal cap.range	33 µF to 1	50 μF	56 μF to 270 μF						
Capacitance tolerance		±20 % (120	Hz / +20℃)						
DC leakage current	I ≤ 0.0	1 CV or 3 (μA) After 2	minutes (whi	chever is greater)					
Dissipation factor (tan δ)		Please see the attach							
	+150 °C ± 2 °C, 1000 h, ap	+150~% ± 2 %, 1000 h, apply the rated ripple current without exceeding the rated voltage.							
	Capacitance change Within ±30% of the initial value								
	Dissipation factor (tan δ)) ≤ 200 % of the initial limit							
Endurance	ESR	≤ 200 % of the initial l							
Endurance	DC leakage current	Within the initial limit							
	ESR after endurance	Size code							
	(Ω / 100 kHz)(-40 °C)	F	G						
		0.4	0.3						
	After storage for 1000 hours at +150 $^{\circ}$ C \pm 2 $^{\circ}$ C with no voltage applied and then being								
Shelf life	stabilized at $+20 ^{\circ}\mathrm{C}$, capacitors shall meet the limits specified in endurance.								
	(With voltage treatment)								
	$+85 \% \pm 2 \%$, 85 % to 90								
	Capacitance change	Within ±30% of the in							
Damp heat (Load)	Dissipation factor (tan δ)	≤ 200 % of the initial l							
	ESR	≤ 200 % of the initial l	limit						
	DC leakage current	Within the initial limit							
	After reflow soldering and the	nen being stabilized at -	⊦20 °C, capac	itors shall meet the					
Resistance to	following limits.								
soldering heat	Capacitance change	Within ±10% of the in	itial value						
Soldering fiedt	Dissipation factor (tan δ)	Within the initial limit							
	DC leakage current	Within the initial limit							

Marking





ZF series

Characteristics list

Endurance : 150 ℃ 1000 h

	Capacitance (±20 %) (µF)	Case size (mm)				Specification			Part number		Min.packaging q'ty
Rated voltage (V)		φD	Standard	Vibration -proof	Size code	Ripple current*1 (mA rms)	ESR ^{*2} (mΩ)	tan δ ^{*3}	Standard Product	Vibration-proof product	Taping (pcs)
25	150	8.0	10.2	10.5	F	800	27	0.14	EEHZF1E151P	EEHZF1E151V	500
25	270	10.0	10.2	10.5	G	1000	20	0.14	EEHZF1E271P	EEHZF1E271V	500
35	100	8.0	10.2	10.5	F	770	30	0.12	EEHZF1V101P	EEHZF1V101V	500
33	150	10.0	10.2	10.5	G	950	23	0.12	EEHZF1V151P	EEHZF1V151V	500
ΕO	56	8.0	10.2	10.5	F	700	35	0.10	EEHZF1H560P	EEHZF1H560V	500
50	100	10.0	10.2	10.5	G	900	28	0.10	EEHZF1H101P	EEHZF1H101V	500
63	33	8.0	10.2	10.5	F	650	40	0.08	EEHZF1J330P	EEHZF1J330V	500
	56	10.0	10.2	10.5	G	840	30	0.08	EEHZF1J560P	EEHZF1J560V	500

^{*1:} Ripple current (100 kHz $/ +150 \, ^{\circ}$ C)

[♦] Please refer to the page of "Reflow profile" and "The taping dimensions".

Frequency correction factor for ripple current										
Rated capacitance (C)	Frequency (f)	100 Hz ≤ f < 200 Hz	200 Hz ≤ f < 300 Hz	300 Hz ≤ f < 500 Hz	500 Hz ≦ f < 1 kHz					
C < 47 µF		0.10	0.10	0.15	0.20					
47 μF ≦ C < 150 μF	Correction factor	0.15	0.20	0.25	0.30					
150 μF ≦ C	lactor	0.15	0.25	0.25	0.30					
Rated capacitance (C)	Frequency (f)	$1 \text{ kHz} \leq f < 2 \text{ kHz}$	$2 \text{ kHz} \le f < 3 \text{ kHz}$	3 kHz ≦ f < 5 kHz	5 kHz ≦ f < 10 kHz					
C < 47 µF		0.30	0.40	0.45	0.50					
47 μF ≦ C < 150 μF	Correction factor	0.40	0.45	0.55	0.60					
150 μF ≦ C	lactor	0.45	0.50	0.60	0.65					
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≤ f < 30 kHz	30 kHz ≤ f < 40 kHz					
C < 47 µF	Compostion	0.60	0.65	0.70	0.75					
47 μF ≦ C < 150 μF	Correction factor	0.70	0.75	0.80	0.80					
150 μF ≦ C	lactor	0.75	0.80	0.85	0.85					
Rated capacitance (C)	Frequency (f)	40 kHz ≦ f < 50 kHz	$50 \text{ kHz} \le f < 100 \text{ kHz}$	100 kHz ≦ f < 500 kHz	500 kHz ≦ f					
C < 47 µF		0.80	0.85	1.00	1.05					
47 μF ≦ C < 150 μF	Correction factor	0.85	0.90	1.00	1.00					
150 μF ≦ C	iactoi	0.85	0.90	1.00	1.00					

^{*2:} ESR (100 kHz / +20 $^{\circ}$ C)

^{*3:} tan δ (120 Hz / +20 °C)



Radial Lead type

ZF series **A** type

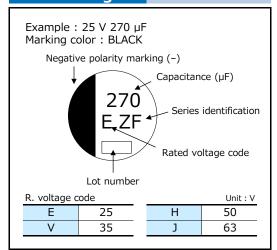


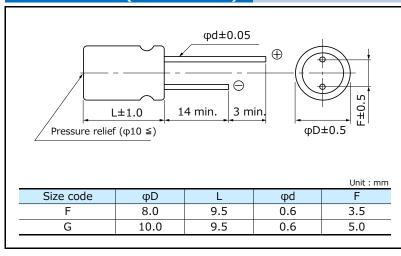
Features

- Endurance : 1000 h at 150 ℃ (High temperature)
- High temperature compared with ZC series
- High-withstand voltage (to 63 V), Low LC (0.01 CV or 3 μA)
- Equivalent to conductive polymer type Aluminum Electrolytic Capacitor (There are little characteristics change by temperature and frequency)
- AEC-Q200 compliant
- RoHS compliant

Specifications							
Size code	F			G			
Category temp. range	−55 °C to +150 °C						
Rated voltage range		25 V to 63 V					
Nominal cap.range	33 μF to 1	50 μF	56 μF to 270 μF				
Capacitance tolerance		±20 %	(120 Hz / +20℃)				
DC leakage current	$I \le 0.01$ CV or 3 (μ A) After 2 minutes (whichever is greater)						
Dissipation factor (tan δ)	Please see the attached characteristics list						
	$+150$ $^{\circ}$ $^{\circ}$ ± 2 $^{\circ}$, 1000 h, ap	ply the rated ripple	current without	exceeding the rated voltage.			
	Capacitance change	Within ±30% of the initial value					
	Dissipation factor (tan δ)	≤ 200 % of the initial limit					
Endurance	ESR ≤ 200 % of the initial limit						
Litatiance	DC leakage current Within the initial limit						
	ESR after endurance $(\Omega / 100 \text{ kHz})(-40 ^{\circ}\text{C})$	Size code					
		F	G				
		0.4	0.3				
	After storage for 1000 hours at +150 $^{\circ}$ C ± 2 $^{\circ}$ C with no voltage applied and then being						
Shelf life	stabilized at $+20 ^{\circ}\mathrm{C}$, capacitors shall meet the limits specified in endurance.						
	(With voltage treatment)						
	$+85 \% \pm 2 \%$, 85 % to 90	%, 2000 h, rated voltage applied					
	Capacitance change	Within ±30% of the initial value					
Damp heat (Load)	Dissipation factor (tan δ)	≤ 200 % of the initial limit					
	ESR	≤ 200 % of the initial limit					
	DC leakage current	Within the initial li	mit				

Marking







ZF-A series

Characteristics list

Endurance : 150 ℃ 1000 h

Rated voltage (V)	Capacitance (±20 %) (µF)	Case size (mm)			Specification				Min.packaging q'ty
		φD	L	Size code	Ripple current *1 (mA rms)	ESR ^{*2} (mΩ)	tan δ ^{*3}	Part number	Long lead (pcs)
25	150	8.0	9.5	F	800	27	0.14	EEHAZF1E151	200
23	270	10.0	9.5	G	1000	20	0.14	EEHAZF1E271	200
35	100	8.0	9.5	F	770	30	0.12	EEHAZF1V101	200
33	150	10.0	9.5	G	950	23	0.12	EEHAZF1V151	200
50	56	8.0	9.5	F	700	35	0.10	EEHAZF1H560	200
50	100	10.0	9.5	G	900	28	0.10	EEHAZF1H101	200
63	33	8.0	9.5	F	650	40	0.08	EEHAZF1J330	200
	56	10.0	9.5	G	840	30	0.08	EEHAZF1J560	200

^{*1:} Ripple current (100 kHz / +150 %)

^{*3:} $\tan \delta (120 \text{ Hz} / +20 ^{\circ}\text{C})$

Frequency correction factor for ripple current									
Rated capacitance (C)	Frequency (f)	100 Hz ≦ f < 200 Hz	200 Hz ≤ f < 300 Hz	300 Hz ≤ f < 500 Hz	500 Hz ≤ f < 1 kHz				
C < 47 µF		0.10	0.10	0.15	0.20				
47 μF ≦ C < 150 μF	Correction factor	0.15	0.20	0.25	0.30				
150 μF ≦ C	Tactor	0.15	0.25	0.25	0.30				
Rated capacitance (C)	Frequency (f)	1 kHz ≦ f < 2 kHz	2 kHz ≦ f < 3 kHz	3 kHz ≦ f < 5 kHz	5 kHz ≤ f < 10 kHz				
C < 47 μF		0.30	0.40	0.45	0.50				
47 μF ≦ C < 150 μF	Correction factor	0.40	0.45	0.55	0.60				
150 μF ≦ C	lactor	0.45	0.50	0.60	0.65				
Rated capacitance (C)	Frequency (f)	10 kHz ≦ f < 15 kHz	15 kHz ≦ f < 20 kHz	20 kHz ≦ f < 30 kHz	30 kHz ≦ f < 40 kHz				
C < 47 μF		0.60	0.65	0.70	0.75				
47 μF ≦ C < 150 μF	Correction factor	0.70	0.75	0.80	0.80				
150 µF ≦ C	lactor	0.75	0.80	0.85	0.85				
Rated capacitance (C)	Frequency (f)	40 kHz ≤ f < 50 kHz	50 kHz ≦ f < 100 kHz	100 kHz ≤ f < 500 kHz	500 kHz ≦ f				
C < 47 µF	Correction	0.80	0.85	1.00	1.05				
47 μF ≦ C < 150 μF		0.85	0.90	1.00	1.00				
150 µF ≦ C	iactor	0.85	0.90	1.00	1.00				

^{*2:} ESR (100 kHz / +20 ℃)

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